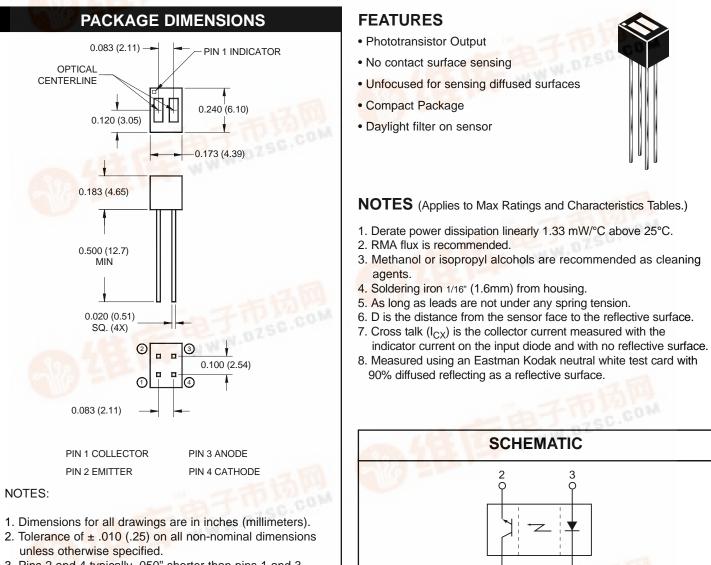


捷多邦,专业PCB打样工厂,24小时加急出货 QRD1113/1114 REFLECTIVE OBJECT SENSOR

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- 3. Pins 2 and 4 typically .050" shorter than pins 1 and 3. 4. Dimensions controlled at housing surface.

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise specified)

Parameter	Symbol	Rating	Units			
Operating Temperature	T _{OPR}	-40 to +85	°C			
Storage Temperature	T _{STG}	-40 to +85	°C			
Lead Temperature (Solder Iron) ^(2,3)	T _{SOL-I}	240 for 5 sec	°C			
Lead Temperature (Solder Flow) ^(2,3)	T _{SOL-F}	260 for 10 sec	°C			
EMITTER						
Continuous Forward Current	I _F	50	mA			
Reverse Voltage	V _R	5	V			
Power Dissipation ⁽¹⁾	PD	100	mW			
SENSORDE						
Collector-Emitter Voltage	V _{CEO}	30	V			
Emitter-Collector Voltage	V _{ECO}		V			
Power Dissipation ⁽¹⁾	PD	100	mW			



SEMICONDUCTOR

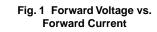
QRD1113/1114 REFLECTIVE OBJECT SENSOR

ELECTRICAL / OPTICAL CHARACTERISTICS (T _A = 25°C)									
PARAMETER	TEST CONDITIONS	SYMBOL	MIN	ТҮР	МАХ	UNITS			
EMITTER	I _F = 20 mA	V _F	_	_	1.7	V			
Forward Voltage	1 _F = 20 mA								
Reverse Current	$V_R = 5 V$	I _R	—		100	μA			
Peak Emission Wavelength	$I_F = 20 \text{ mA}$	λ_{PE}	—	940	_	nm			
SENSOR	I _C = 1 mA	BV _{CEO}	30	_	_	V			
Collector-Emitter Breakdown	$I_{\rm C} = 1$ IIIA								
Emitter-Collector Breakdown	I _E = 0.1 mA	BV _{ECO}	5	_	_	V			
Dark Current	$V_{CE} = 10 \text{ V}, \text{ I}_{F} = 0 \text{ mA}$	Ι _D	—	_	100	nA			
COUPLED	$I_{\rm F}$ = 20 mA, $V_{\rm CE}$ = 5 V	I _{C(ON)}	0.300	—	—	mA			
QRD1113 Collector Current	D = .050" (6,8)	·C(ON)							
QRD1114 Collector Current	$I_F = 20 \text{ mA}, V_{CE} = 5 \text{ V}$	I _{C(ON)}	1	_	_	mA			
	D = .050" ^(6,8)								
Collector Emitter	IF = 40 mA, Ic = 100 μA	VCE (SAT)	_	_	0.4	V			
Saturation Voltage	D = .050" ^(6,8)								
Cross Talk I _F	= 20 mA, V_{CE} = 5 V, E_E = 0 ⁽⁷⁾	I _{CX}		.200	10	μA			
Rise Time	V_{CE} = 5 V, R_L = 100 Ω	tr	_	10	_	μs			
Fall Time	$I_{C(ON)} = 5 \text{ mA}$	tr	—	50	—	μs			



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TYPICAL PERFORMANCE CURVES



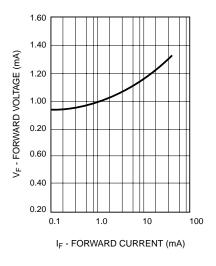
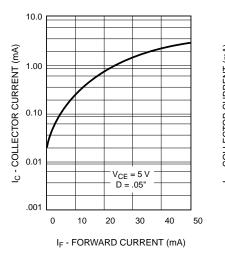




Fig. 3 Normalized Collector Current vs. Temperature



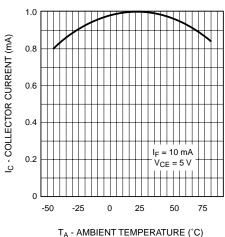


Fig. 4 Normalized Collector Dark Current vs. Temperature

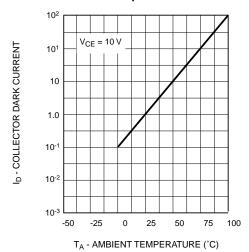
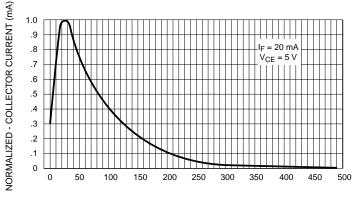


Fig. 5 Normalized Collector Current vs. Distance



REFLECTIVE SURFACE DISTANCE (mils)



QRD1113/1114 REFLECTIVE OBJECT SENSOR

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